2SD1745

Silicon NPN epitaxial planar type

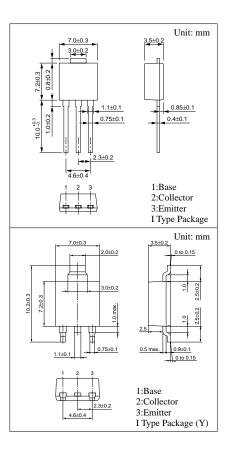
For power switching Complementary to 2SB1175

Features

- Low collector to emitter saturation voltage V_{CE(sat)}
- Satisfactory linearity of foward current transfer ratio h_{FE}
- Large collector current I_C
- I type package enabling direct soldering of the radiating fin to the printed circuit board, etc. of small electronic equipment.

Absolute Maximum Ratings (T_C=25°C)

Parameter		Symbol	Ratings	Unit	
Collector to base voltage		V_{CBO}	130	V	
Collector to emitter voltage		V_{CEO}	80	V	
Emitter to base voltage		V_{EBO}	7	V	
Peak collector current		I _{CP}	8	A	
Collector current		I_{C}	4	A	
Collector power	T _C =25°C	D	15	***	
dissipation	Ta=25°C	P_{C}	1.3	W	
Junction temperature		Tj	150	°C	
Storage temperature		T_{stg}	-55 to +150	°C	



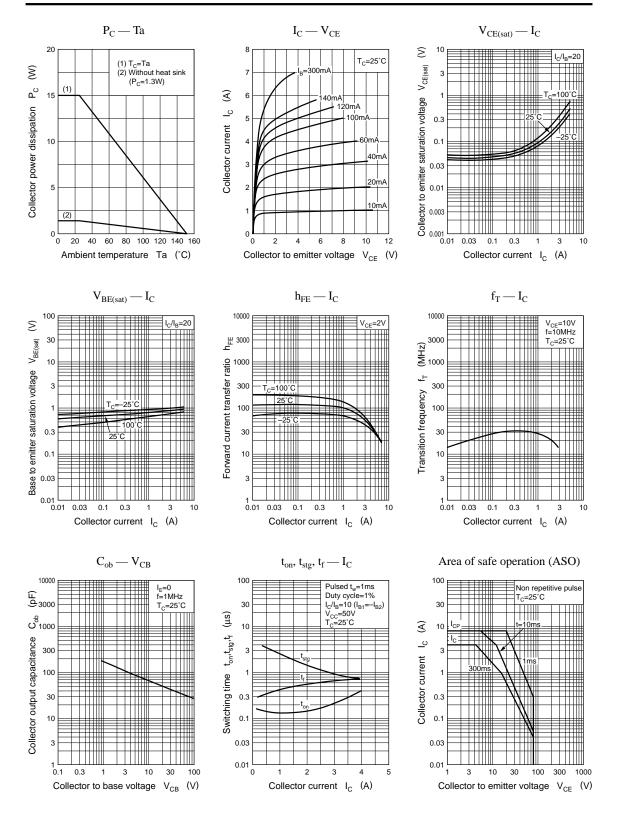
■ Electrical Characteristics (T_C=25°C)

Parameter	Symbol	Conditions	min	typ	max	Unit
Collector cutoff current	I _{CBO}	$V_{CB} = 100V, I_E = 0$			10	μА
Emitter cutoff current	I _{EBO}	$V_{EB} = 5V, I_C = 0$			50	μА
Collector to emitter voltage	V _{CEO}	$I_C = 10 \text{mA}, I_B = 0$	80			V
Forward current transfer ratio	h _{FE1}	$V_{CE} = 2V, I_{C} = 0.1A$	45			
	h _{FE2} *	$V_{CE} = 2V$, $I_C = 1A$	90		260	
Collector to emitter saturation voltage	V _{CE(sat)}	$I_C = 3A, I_B = 0.15A$			0.5	V
Base to emitter saturation voltage	V _{BE(sat)}	$I_C = 3A, I_B = 0.15A$			1.5	V
Transition frequency	f_T	$V_{CE} = 10V, I_{C} = 0.5A, f = 10MHz$		30		MHz
Turn-on time	t _{on}	1 14 1 014 1 014		0.5		μs
Storage time	t _{stg}	$I_C = 1A, I_{B1} = 0.1A, I_{B2} = -0.1A,$		2.5		μs
Fall time	t _f	$V_{CC} = 50V$		0.15		μs

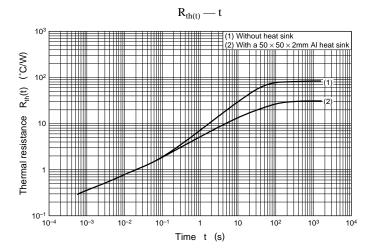
*h_{FE2} Rank classification

Rank	Q	P		
h _{FE2}	90 to 180	130 to 260		

Power Transistors 2SD1745



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